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PRODUCT RELIABILITY REPORT
FOR

DS2483

Maxim Integrated Products

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Prepared by:

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Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Maxim products:

DS2483

In addition, Maxim's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport /dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts
AfT = Acceleration factor due to Temperature
tu = Time at use temperature (e.g. 55°C)
ts = Time at stress temperature (e.g. 125°C)
k = Boltzmann's Constant (8.617 x 10-5 eV/°K)
Tu = Temperature at Use (°K)
Ts = Temperature at Stress (°K)
Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

AfV = exp(B*(Vs - Vu))
AfV = Acceleration factor due to Voltage
Vs = Stress Voltage (e.g. 7.0 volts)
Vu = Maximum Operating Voltage (e.g. 5.5 volts)
B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

Fr = X/(ts * AfV * AfT * N * 2)
X = Chi-Sq statistical upper limit
N = Life test sample size

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE:	**MTTF (YRS):**	**4783**	**FITS:**	**23.9**
	DEVICE HOURS:	**38390674**	**FAILS:**	**0**

Only data from Operating Life or similar stresses are used for this calculation.

The parameters used to calculate this failure rate are as follows:

Cf: 60% **Ea: 0.7** **B: 0** **Tu: 25** **°C** **Vu: 5.25** **Volts**

The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. **Bold** Product Number denotes specific product data.

Device Information:

Process:	Maxim X3 Fab S18M 5V CMOS, 2V CMOS, 4 metals
Passivation:	SiN / SiO2
Die Size:	57 x 40
Number of Transistors:	21438
Interconnect:	Aluminum / 0.5% Copper
Gate Oxide Thickness:	140Å

ESD HBM

DESCRIPTION	DATE CODE/PRODUCT/LOT			CONDITION	READPOIN		QTY	FAILS	FA#
ESD SENSITIVITY	1143	**DS2483**	ZD214700BC	JESD22-A114 HBM 500 VOLTS	1	PUL'S	5	0	
ESD SENSITIVITY	1143	**DS2483**	ZD214700BC	JESD22-A114 HBM 1000 VOLTS	1	PUL'S	5	0	
ESD SENSITIVITY	1143	**DS2483**	ZD214700BC	JESD22-A114 HBM 1500 VOLTS	1	PUL'S	5	0	
ESD SENSITIVITY	1143	**DS2483**	ZD214700BC	JESD22-A114 HBM 2000 VOLTS	1	PUL'S	5	0	
ESD SENSITIVITY	1143	**DS2483**	ZD214700BC	JESD22-A114 HBM 4000 VOLTS	1	PUL'S	5	5	No FA
ESD SENSITIVITY	1143	**DS2483**	ZD214700BC	JESD22-A114 HBM 6000 VOLTS	1	PUL'S	5	0	
ESD SENSITIVITY	1143	**DS2483**	ZD214700BC	JESD22-A114 HBM 7000 VOLTS	1	PUL'S	5	0	
ESD SENSITIVITY	1143	**DS2483**	ZD214700BC	JESD22-A114 HBM 8000 VOLTS	1	PUL'S	5	0	
					Total:			**5**	

LATCH-UP

DESCRIPTION	DATE CODE/PRODUCT/LOT			CONDITION	READPOIN	QTY	FAILS	FA#
LATCH-UP I	1143	**DS2483**	ZD214700BC	JESD78A, I-TEST 25C 100mA		6	0	

LATCH-UP I	1143	**DS2483**	ZD214700BC	JESD78A, I-TEST 25C 250mA		6	0
LATCH-UP V	1143	**DS2483**	ZD214700BC	JESD78A, V-SUPPLY TEST 25C		6	0
					Total:		**0**

OPERATING LIFE

DESCRIPTION	DATE CODE/PRODUCT/LOT			CONDITION	READPOIN		QTY	FAILS	FA#
HIGH TEMP OP LIFE	1003	MAX17042	QJ000200DA	125C, 5.5 VOLTS	192	HRS	45	0	
HIGH TEMP OP LIFE	1018	DS28E10	QH000900A	125C, 3.6 VOLTS	192	HRS	45	0	
HIGH TEMP OP LIFE	1134	MAX17048	ZJ213800AB	125C, 5.0 VOLTS	192	HRS	77	0	
HIGH TEMP OP LIFE	1143	**DS2483**	ZD214700BC	125C, 5.25 VOLTS	192	HRS	45	0	
					Total:			**0**	

FAILURE RATE: **MTTF (YRS):** **4783** **FITS:** **23.9**

DEVICE HOURS: **38390674** **FAILS:** **0**

All pins were stressed for ESD results through 4KV. Only I/O and GND pins were stressed for ESD results of 6KV, 7KV and 8KV.